

1. Features

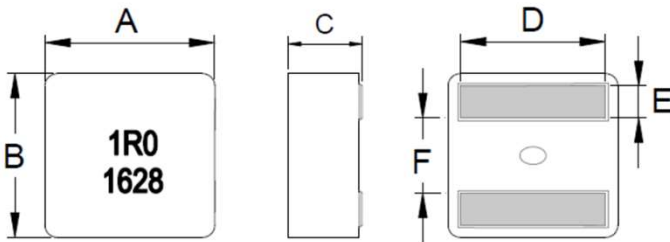
1. Soft saturation.
2. High current › low DCR › high efficiency.
3. Very low acoustic noise and very low leakage flux noise.
4. High reliability.
5. 100% Lead(Pb)-Free and RoHS compliant.



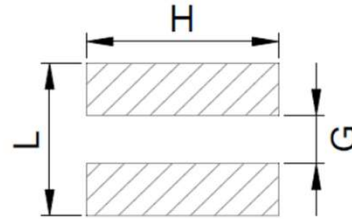
2. Applications

Note PC power system › incl. IMVP-6
DC/DC converter .

3. Dimensions



Recommend PC Board Pattern



L(mm)	G(mm)	H(mm)
4.5 ref	2.0 ref	4.7 ref

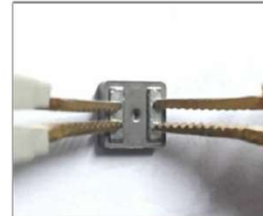
Note: 1. The above PCB layout reference only.
2. Recommend solder paste thickness at 0.12mm and above.

Series	A (mm)	B (mm)	C (mm)	D (mm)	E (mm)	F (mm)
TMPF0502A	5.5±0.2	5.3±0.2	1.9±0.2	4.3±0.3	1.1±0.2	2.3±0.25

4. Part Numbering

TMPF **0502** **A** - **1R0** **MN** - **D**
A B C D E F

A: Series
B: Dimension BxC
C: Type Material.
D: Inductance 1R0=1.00uH
E: Inductance Tolerance M=±20%
F: Code Marking: Black. 1R0 and 1628(16 YY, 28 WW, follow production date).



DCR Test

5. Specification

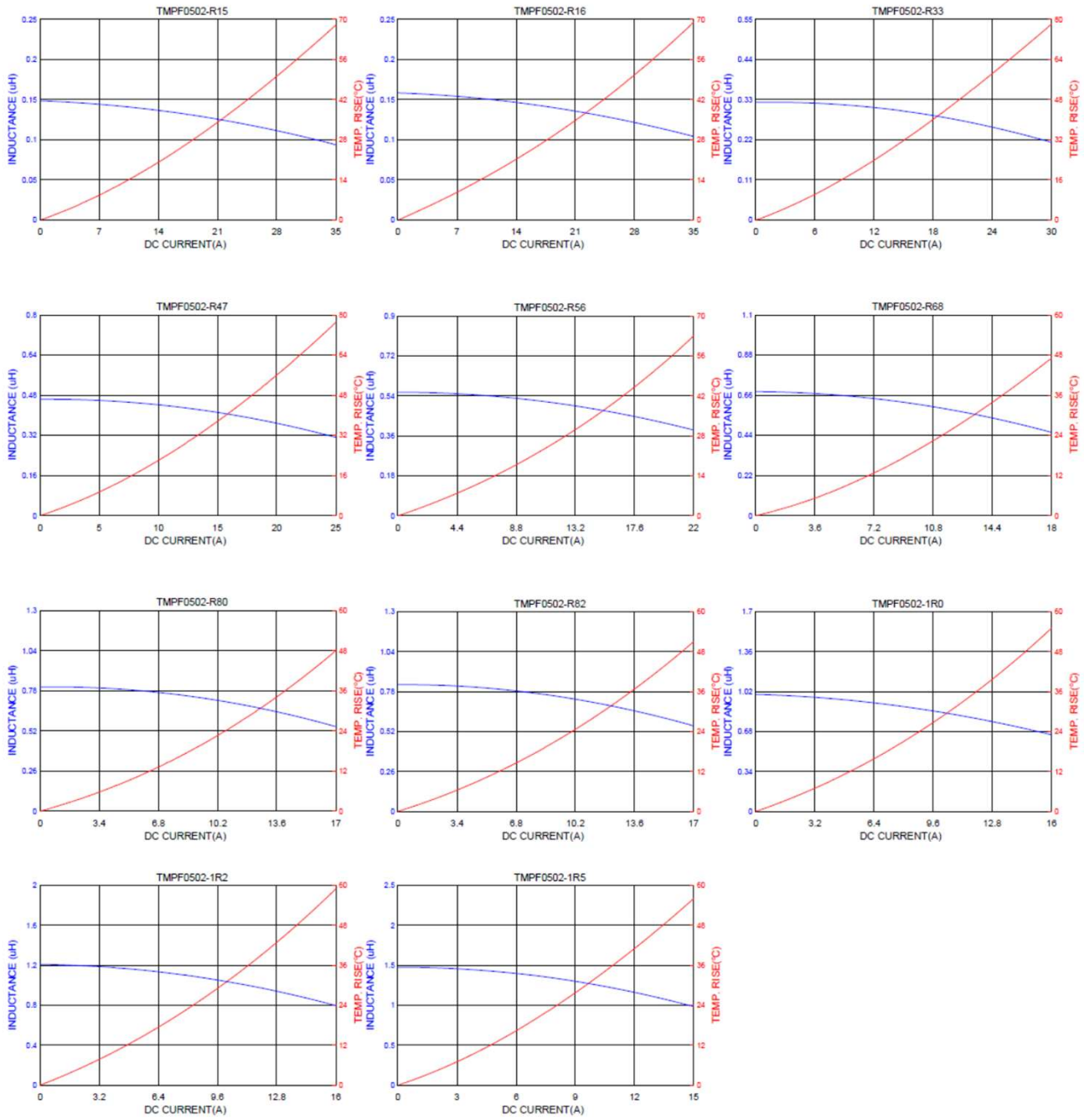
Part Number	Inductance (uH) $\pm 20\%$ @ 0 A	I rms(A) Typ		I sat(A)		DCR(m Ω) Typ.	DCR(m Ω) Max.
		20°C rise	40°C rise	Typ	Max		
TMPF0502A-R15MN-D	0.15	13.9	18.8	30.0	27.0	4.00	4.60
TMPF0502A-R16MN-D	0.16	13.9	18.8	30.0	27.0	4.00	4.60
TMPF0502A-R33MN-D	0.33	10.5	14.4	26.0	24.0	6.10	7.00
TMPF0502A-R47MN-D	0.47	10.1	14.1	22.0	20.0	7.00	8.05
TMPF0502A-R56MN-D	0.56	9.9	13.9	19.0	16.0	8.70	9.54
TMPF0502A-R68MN-D	0.68	9.6	13.4	16.0	14.0	8.90	10.2
TMPF0502A-R80MN-D	0.80	9.4	13.0	15.5	13.5	10.3	11.8
TMPF0502A-R82MN-D	0.82	8.5	12.0	15.0	13.0	11.0	12.7
TMPF0502A-1R0MN-D	1.00	7.5	10.5	14.5	12.8	12.0	13.8
TMPF0502A-1R2MN-D	1.20	6.8	9.40	14.0	12.2	14.2	16.3
TMPF0502A-1R5MN-D	1.50	6.4	8.80	13.3	11.7	16.2	18.7

Note:

1. Test frequency : L : 100KHz /0.1V.
2. All test data referenced to 25°C ambient.
3. Testing Instrument : L/Q: HP4284A,HP4395A,CH11025,CH3302,CH1320 ,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER,or EQU.
4. Current that causes the specified temperature rise from 25°C ambient.
5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
6. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions.Circuit design,component,PCB trace size and thickness,airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. Special inquiries besides the above common used types can be met on your requirement.

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6. Typical Performance Curves



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